

Continental Device India Limited

An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company



SILICON PLANAR EPITAXIAL TRANSISTORS



BC327/A BC328 PNP BC337/A BC338 NPN

TO-92 Plastic Package

For Lead Free Parts, Device Part # will be Prefixed with "T"

General Purpose Transistors Best Suited for use in Driver and Output Stages of Audio Amplifier

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	BC327/337	BC327A/337A	BC328/338	UNITS
	STIVIDUL	DC3ZII33I	BC32/A/33/A	DC320/330	UNITS
Collector Emitter Voltage	V_{CEO}	45	60	25	V
Collector Emitter Voltage	V_{CES}	50	V		
Emitter Base Voltage	V_{EBO}		V		
Collector Current Continuous	Ic		800		mA
Collector Current Peak	I _{CM}		mA		
Emitter Current Peak	I _{EM}		mA		
Base Current Continuous	Ι _Β		mA		
Base Current Peak	I _{BM}		mA		
Power Dissipation at T _a =25°C	P_D		mW		
Derate Above 25°C			mW/ºC		
Operating And Storage Junction Temperature Range	T_{j} , T_{stg}		°C		

THERMAL RESISTANCE

Junction to Ambient in free air	$R_{th (i-a)}$	200	°C/W

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Collector Emitter Voltage	V_{CEO}	$I_C=1$ mA, $I_B=0$			
		BC327/337	45		V
		BC327A/337A	60		V
		BC328/338	25		V
Collector Emitter Voltage	V_{CES}	$I_C = 100 \mu A, I_E = 0$			
		BC327/337	50		V
		BC327A/337A	60		V
		BC328/338	30		V
Emitter Base Voltage	V_{EBO}	$I_{E}=10\mu A, I_{C}=0$	5.0		V
Collector Cut Off Current	I _{CBO}	$V_{CB}=20V, I_{E}=0$		100	nA
		V_{CB} =20V, I_E =0, T_J =150 °C		5	μΑ
Emitter Cut Off Current	I _{EBO}	$V_{EB}=5V$, $I_{C}=0$		10	μΑ
Collector Emitter Saturation Voltage	*V _{CE (sat)}	I_C =500mA, I_B =50mA		0.7	V
Base Emitter On Voltage	*V _{BE (on)}	I_C =500mA, V_{CE} =1V		1.2	V

^{*}Pulse Test: Pulse Width < 300ms, Duty Cycle < 2%

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ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
DC Current Gain	*h _{FE}	I _C =100mA, V _{CE} =1V			
		BC327A/337A	100	400	
		BC327/328, BC337/338	100	600	
		BC327/328, BC337/338			
		Group-10	63	160	
		Group-16	100	250	
		Group-25	160	400	
		Group-40	250	600	
		I_C =500mA, V_{CE} =1V	40		

SMALL SIGNAL CHARACTERISTICS

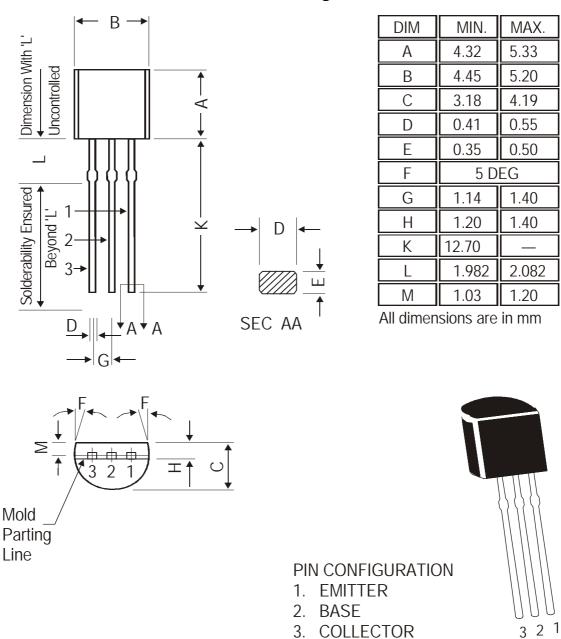
DESCRIPTION	SYMBOL	TEST CONDITION	TYP	UNITS
Transistors Frequency	f _T	$I_C=10$ mA, $V_{CE}=5$ V, $f=35$ MHz		
		NPN	200	MHz
		PNP	100	MHz
Output Capacitance	C _{ob}	V_{CB} =10V, I_{E} =0, f=1MHz		
		NPN	5	pF
		PNP	8	pF

^{*}Pulse Test: Pulse Width ≤ 300ms, Duty Cycle ≤ 2%

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TO-92 Plastic Package



The TO-92 Package, Tape and Ammo Pack drawings are correct as on the date of issue/revision of this Data Sheet.

The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

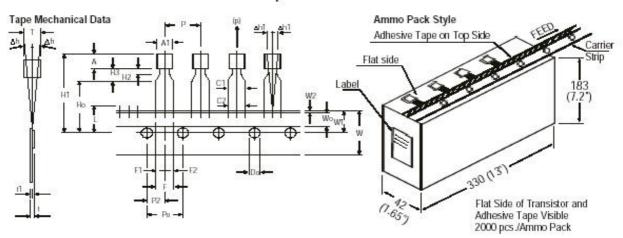
Packing Details

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details Net Weight/Oty		Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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TO-92 Tape and Ammo Pack



All dimensions are in mm

		SPECIFICATION				
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.45	- 3	5.20	ř.	NOTES
BODY HEIGHT	Α	4.32		5.33		Maximum alignment deviation between
BODY THICKNESS	T	3.18		4.19		leads will not to be greater than 0.2mm.
PITCH OF COMPONENT	P		12.7		± 1.0	2. Maximum non-cumulative variation
*1FEED HOLE PITCH	Po		12.7		± 0.3	between tape feed holes shall not
*2 FEED HOLE CENTRE TO			VXXXXXX			exceed 1 mm in 20 pitches.
COMPONENT CENTRE	P2		6.35		± 0.4	3. Holddown tape will not exceed beyond
DISTANCE BETWEEN OUTER LEADS	E		5.08		+ 0.6	the edge(s) of carrier tape and there shall be no exposure of adhesive.
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0		4. There will be no more than three (3)
*4 COMPONENT ALIGNMENT FRONT VIEW	Δh1		0	1.3		consecutive missing components in a
TAPE WIDTH	W		18	0.000	± 0.5	tape.
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	A tape trailer, having at least three feed
HOLE POSITION	W1		9		+ 0.7	holes are provided after the last component in a tape.
HOLD-DOWN TAPE POSITION	W2	0.0		0.7		Splices should not interfere with the
LEAD WIRE CLINCH HEIGHT	Но	1000000	16	11000000	± 0.5	sprocket feed holes.
COMPONENT HEIGHT	H1		1250	24.0		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	REMARKS
*5 TOTAL TAPE THICKNESS	t			1.2		
LEAD - TO - LEAD DISTANCE	F1, F2	2.40		2.70		*1 Cumulative pitch error 1.0 mm/20 pitch
STAND OFF	H2	0.45		1.45	- 0.1	*2 To be measured at bottom of clinch
CLINCH HEIGHT	НЗ			3.0		*3 At top of body
LEAD PARALLELISM	C1 - C2			0.22		*4 At top of body
PULL - OUT FORCE	(p)	6N		140000000		*5 t1 0.3 – 0.6 mm

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Customer Notes

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Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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